Self-Protected Low Side Driver with Temperature and Current Limit

NCV8402/A is a three terminal protected Low–Side Smart Discrete device. The protection features include overcurrent, overtemperature, ESD and integrated Drain–to–Gate clamping for overvoltage protection. This device offers protection and is suitable for harsh automotive environments.

Features

- Short-Circuit Protection
- Thermal Shutdown with Automatic Restart
- Overvoltage Protection
- Integrated Clamp for Inductive Switching
- ESD Protection
- dV/dt Robustness
- Analog Drive Capability (Logic Level Input)
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Switch a Variety of Resistive, Inductive and Capacitive Loads
- Can Replace Electromechanical Relays and Discrete Circuits
- Automotive / Industrial

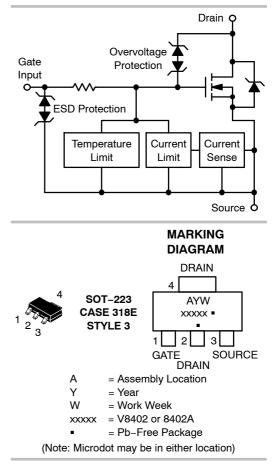


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS} (Clamped)	R _{DS(ON)} TYP	I _D MAX
42 V	165 mΩ @ 10 V	2.0 A*

*Max current limit value is dependent on input condition.



ORDERING INFORMATION

Device	Package	Shipping [†]
NCV8402STT1G	SOT-223	1000/Tape & Reel
NCV8402ASTT1G	(Pb-Free)	
NCV8402STT3G	SOT-223	4000/Tape & Reel
NCV8402ASTT3G	(Pb-Free)	

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

	Rating	Symbol	Value	Unit
Drain-to-Source Voltage Internally Cl	amped	V _{DSS}	42	V
Drain-to-Gate Voltage Internally Clar	nped $(R_G = 1.0 M\Omega)$	V _{DGR}	42	V
Gate-to-Source Voltage		V _{GS}	±14	V
Continuous Drain Current		Internally Limi		
Power Dissipation	@ T _A = 25°C (Note 1) @ T _A = 25°C (Note 2) @ T _T = 25°C (Note 1)	PD	1.1 1.7 8.9	W
Thermal Resistance	Junction-to-Ambient Steady State (Note 1) Junction-to-Ambient Steady State (Note 2) Junction-to-Tab Steady State (Note 1)	R _{θJA} R _{θJA} R _{θJT}	114 72 14	°C/W
Single Pulse Drain–to–Source Avalanch (V_DD = 32 V, V_G = 5.0 V, I_{PK} = 1.0 A, I		E _{AS}	150	mJ
Load Dump Voltage	$(V_{GS} = 0 \text{ and } 10 \text{ V}, \text{ R}_{I} = 2.0 \Omega, \text{ R}_{L} = 9.0 \Omega, \text{ t}_{d} = 400 \text{ ms})$	V_{LD}	87	V
Operating Junction Temperature		Τ _J	-40 to 150	°C
Storage Temperature		T _{stg}	-55 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted onto min pad FR4 PCB, (2 oz. Cu, 0.06" thick).

2. Surface-mounted onto 2" sq. FR4 board (1" sq., 1 oz. Cu, 0.06" thick).

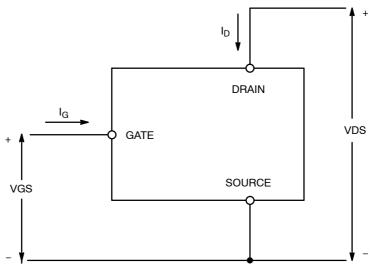


Figure 1. Voltage and Current Convention

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Test Condition	Test Condition Symbol Min		Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V_{GS} = 0 V, I _D = 10 mA, T _J = 25°C	V _{(BR)DSS}	42	46	55	V
(Note 3)	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$ (Note 5)		40	45	55	
Zero Gate Voltage Drain Current	$V_{GS} = 0 \text{ V}, \text{ V}_{DS} = 32 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C}$	I _{DSS}		0.25	4.0	μA
	$V_{GS} = 0 \text{ V}, V_{DS} = 32 \text{ V}, T_{J} = 150^{\circ}\text{C}$ (Note 5)			1.1	20	
Gate Input Current	$V_{DS} = 0 V, V_{GS} = 5.0 V$	I _{GSSF}		50	100	μA
ON CHARACTERISTICS (Note 3)						
Gate Threshold Voltage	$V_{00} = V_{00}$ lp = 150 µA	Vec	13	18	22	V

Gale Threshold Vollage	v _{GS} = v _{DS} , I _D = 150 μA	VGS(th)	1.3	1.8	2.2	v
Gate Threshold Temperature Coefficient		V _{GS(th)} /T _J		4.0		−mV/°C
Static Drain-to-Source On-Resistance	V_{GS} = 10 V, I _D = 1.7 A, T _J = 25°C	R _{DS(on)}		165	200	mΩ
	V _{GS} = 10 V, I _D = 1.7 A, T _J = 150°C (Note 5)			305	400	
	V_{GS} = 5.0 V, I_D = 1.7 A, T_J = 25°C			195	230	
	V_{GS} = 5.0 V, I _D = 1.7 A, T _J = 150°C (Note 5)			360	460	
	V_{GS} = 5.0 V, I _D = 0.5 A, T _J = 25°C			190	230	
	V _{GS} = 5.0 V, I _D = 0.5 A, T _J = 150°C (Note 5)			350	460	
Source-Drain Forward On Voltage	V _{GS} = 0 V, I _S = 7.0 A	V _{SD}		1.0		V

SWITCHING CHARACTERISTICS (Note 5)

Turn–ON Time (10% V _{IN} to 90% I _D)	V _{GS} = 10 V, V _{DD} = 12 V	t _{ON}	25	μs
Turn-OFF Time (90% V _{IN} to 10% I _D)	I_{D} = 2.5 A, R_{L} = 4.7 Ω	t _{OFF}	120	
Slew-Rate ON (70% V_{DS} to 50% $V_{DS})$	V _{GS} = 10 V, V _{DD} = 12 V,	-dV _{DS} /dt _{ON}	0.8	V/µs
Slew-Rate OFF (50% V_{DS} to 70% $V_{DS})$	$R_L = 4.7 \ \Omega$	dV _{DS} /dt _{OFF}	0.3	

SELF PROTECTION CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted) (Note 4)

Current Limit	V_{DS} = 10 V, V_{GS} = 5.0 V, T_{J} = 25°C	I _{LIM}	3.7	4.3	5.0	А
	V _{DS} = 10 V, V _{GS} = 5.0 V, T _J = 150°C (Note 5)		2.3	3.0	3.7	
	V_{DS} = 10 V, V_{GS} = 10 V, T_{J} = 25°C		4.2	4.8	5.4	
	V _{DS} = 10 V, V _{GS} = 10 V, T _J = 150°C (Note 5)		2.7	3.6	4.5	
Temperature Limit (Turn-off)	V _{GS} = 5.0 V (Note 5)	T _{LIM(off)}	150	175	200	°C
Thermal Hysteresis	V _{GS} = 5.0 V	$\Delta T_{LIM(on)}$		15		
Temperature Limit (Turn-off)	V _{GS} = 10 V (Note 5)	T _{LIM(off)}	150	165	185	
Thermal Hysteresis	V _{GS} = 10 V	$\Delta T_{LIM(on)}$		15		

GATE INPUT CHARACTERISTICS (Note 5)

Device ON Gate Input Current	$V_{GS} = 5 \text{ V I}_{D} = 1.0 \text{ A}$	I _{GON}	50	μA
	V _{GS} = 10 V I _D = 1.0 A	-	400	
Current Limit Gate Input Current	$V_{GS} = 5 \text{ V}, V_{DS} = 10 \text{ V}$	I _{GCL}	0.05	mA
	V_{GS} = 10 V, V_{DS} = 10 V		0.4	
Thermal Limit Fault Gate Input Current	$V_{GS} = 5 \text{ V}, V_{DS} = 10 \text{ V}$	I _{GTL}	0.15	mA
	V _{GS} = 10 V, V _{DS} = 10 V		0.7	

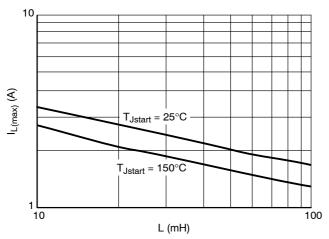
ESD ELECTRICAL CHARACTERISTICS (T_J = 25 $^{\circ}\text{C}$ unless otherwise noted) (Note 5)

Electro-Static Discharge Capability	Human Body Model (HBM)	ESD	4000		V
	Machine Model (MM)		400		

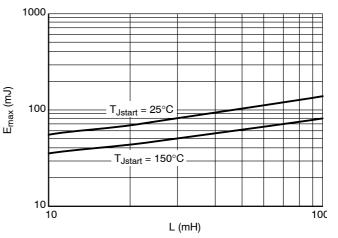
Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Fault conditions are viewed as beyond the normal operating range of the part.

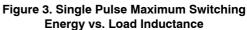
5. Not subject to production testing.

TYPICAL PERFORMANCE CURVES









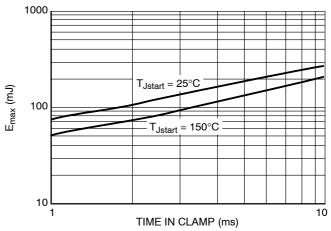


Figure 5. Single Pulse Maximum Inductive Switching Energy vs. Time in Clamp

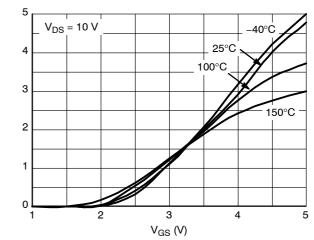
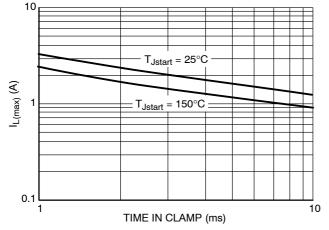
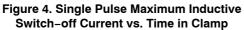


Figure 7. Transfer Characteristics





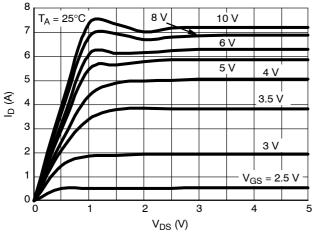
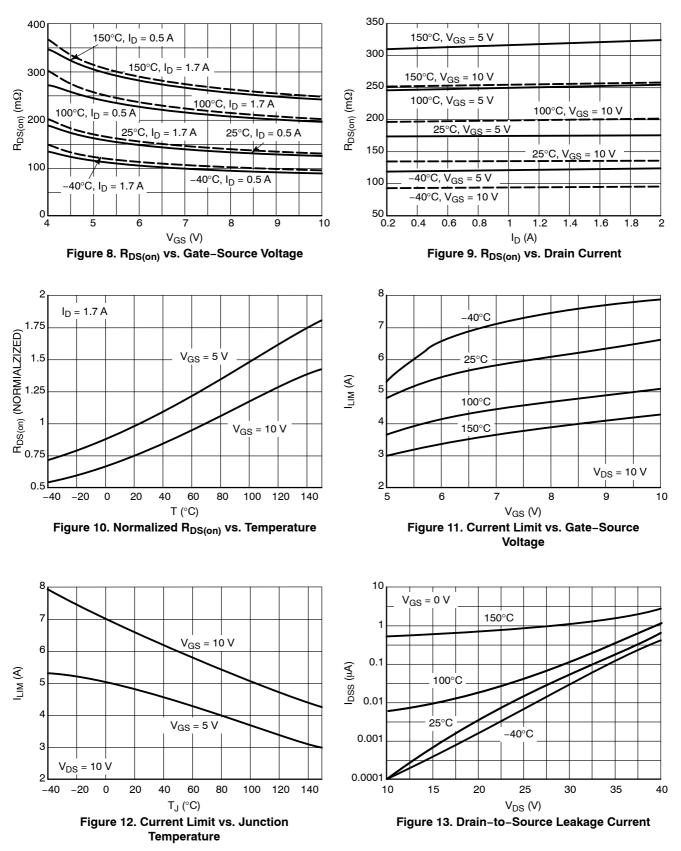


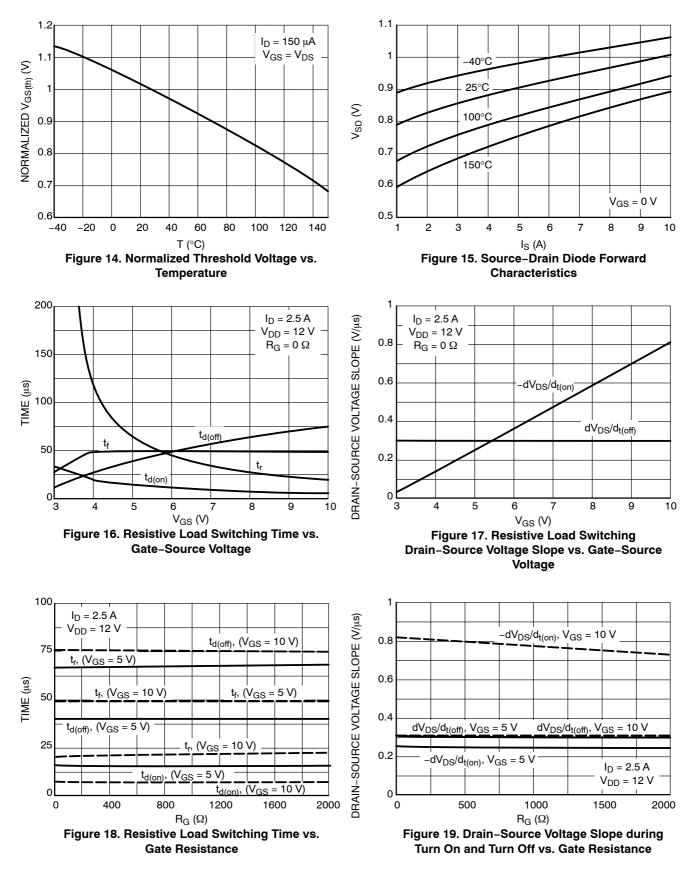
Figure 6. On-state Output Characteristics

I_D (A)

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES

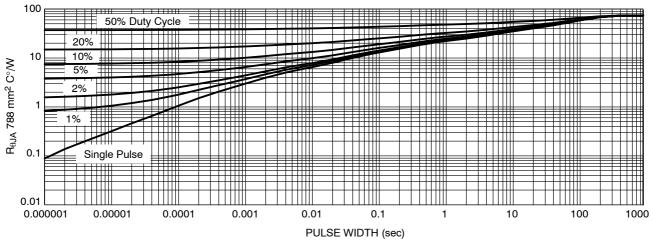


Figure 20. Transient Thermal Resistance

TEST CIRCUITS AND WAVEFORMS

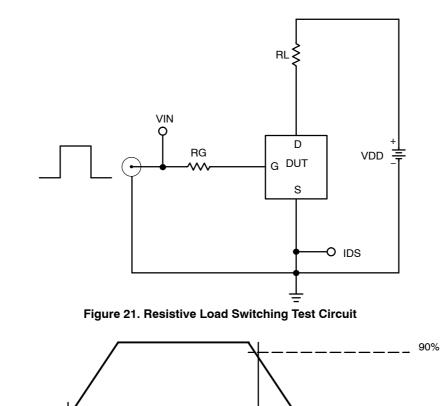


Figure 22. Resistive Load Switching Waveforms

td(OFF)

tf

VIN

IDS

td(ON)

tr

10%

90%

10%

TEST CIRCUITS AND WAVEFORMS

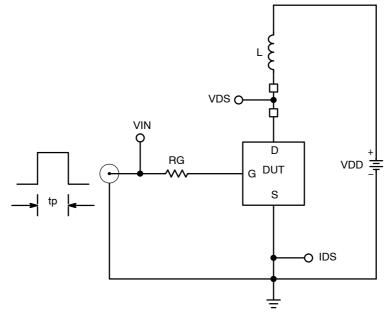


Figure 23. Inductive Load Switching Test Circuit

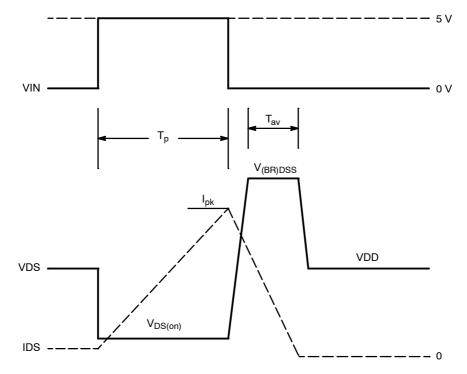
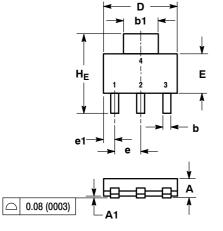
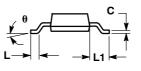


Figure 24. Inductive Load Switching Waveforms

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 ISSUE N

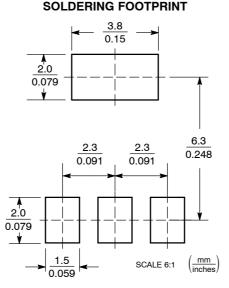




NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
с	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
Е	3.30	3.50	3.70	0.130	0.138	0.145
е	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20			0.008		
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	_	10°	0°	_	10°

STYLE 3: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN



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